

SIEMENS

PATENT
Attorney Docket No. 2003P18131WOUS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

| | | | |
|-------------|---|-------------------|-----------------|
| Inventor: | D. Goldschmidt et al.) | Confirmation No.: | 1234 |
| |) | | |
| Serial No.: | 10/588,024) | Examiner: | Michael Aboagye |
| |) | | |
| Filed: | May 31, 2007) | Group Art Unit: | 1793 |
| |) | | |
| Title: | REPAIR SOLDERING METHOD FOR REPAIRING A COMPONENT WHICH COMPRISES A BASE MATERIAL WITH AN ORIENTED MICROSTRUCTURE | | |

Commissioner For Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

RESPONSE TO FINAL OFFICE ACTION

In response to the Office Action mailed July 27, 2010, Applicant respectfully submits the following amendments and remarks in connection with the above-identified application to place the claims in condition for allowance or to place the claims in better form for appeal. The following are provided herewith:

**Amendments to the Claims, and
Remarks/Arguments.**